Electronics Components World

The Components Industry's E-Zine

HOME

NEWS

TECH ARTICLES

PRODUCTS

PEOPLE W

WHITE PAPERS

Search...

BREAKING NEWS:

FPGAs Help Characterize Massiv

Industry News

IDT Collaborates With CERN to Speed and Improve Data Analytics at Large Hadron Collider and Data Center

Tuesday, April 7, 2015

In a Three-Year Arrangement, IDT's Low-Latency RapidlO Interconnect Technology Will Be Used for More Efficient and Effective Analysis of Massive Data at CERN

Integrated Device Technology, Inc. (IDT®) (NASDAQ:IDTI) announced today that it has entered a three-year collaboration with the European Organization for Nuclear Research (CERN) to use IDT's RapidIO technology to help improve data acquisition and analysis in some of the world's most advanced fundamental physics research.

Massive volumes of data are collected by the experiments on **CERN's Large Hadron Collider (LHC)**, one of the world's largest and most powerful particle accelerators. Teams from **IDT** and **CERN** will use the IDT technology to improve the quality and timeliness of this data collection, as well as the initial analysis and reconstruction work at the experiments' data farms and the CERN Data Centre.

The LHC produces millions of collisions every second in each detector, generating approximately one petabyte of data per second. This data is vital to CERN's quest to answer fundamental questions about the universe. The **RapidIO** technology provides a low-latency connection between clusters of computer processors, dramatically speeding the movement of data. Widely used for 4G base stations, IDT's low-latency RapidIO products can also enable real-time data analytics and data management for high-performance computing (HPC) and data centers.

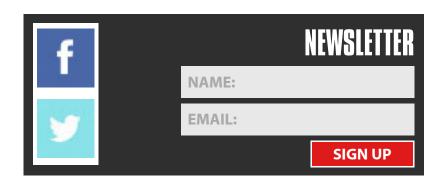
As part of the mandate for the fifth phase of the CERN openlab partnership, several of the LHC experiments are exploring the possibility of moving from custom-built hardware and backplanes to fully programmable heterogeneous computing with low-latency interconnect between large clusters of processors. IDT's current RapidlO 20 Gbps interconnect products will be used in the first stage of the collaboration with an upgrade path to RapidlO 10xN 40 Gbps technology in the future as research at CERN progresses.

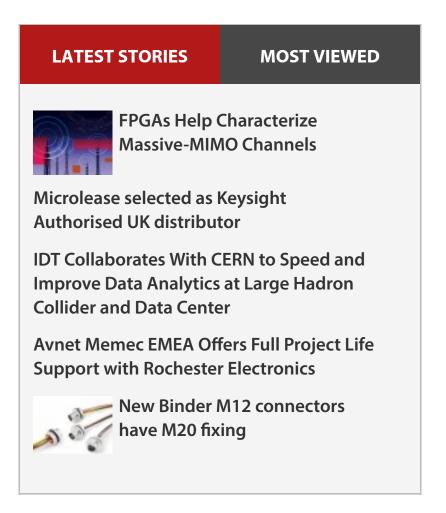
"This CERN collaboration is about enabling programmable real-time mission critical data analytics," said **Sailesh Chittipeddi**, IDT's vice president of Global Operations and chief technology officer. "Since the job spans multiple processors, the interconnect between them has to be ultra-low latency, and our technology—already used across 4G wireless base station deployments worldwide—is ideally suited to CERN's real-time interconnect needs."

Because of the volume of real-time data CERN collects, current implementations are done in custom-built ASIC hardware. Using algorithms implemented in hardware, the data is sampled, and only 1 percent is selected for further analysis.

"The bottleneck for better data acquisition, selection and analytics is superior real-time interconnect," said **Alberto Di Meglio**, head of CERN openlab. "Our collaboration with IDT to develop a RapidIO-based computing architecture should help solve CERN's real-time data filtering problem, enabling us to select and utilize more meaningful events from the LHC and improve efficiency of analytics in our data center monitoring and operations."

The collaboration is based on industry standard IT form factor solutions suitable for deployment in HPC clusters and data centers. Engineers will use heterogeneous servers based on specifications from RapidlO.org that are targeted towards the Open Compute Project High Performance Computing initiative that IDT co-chairs.









FPGAs Help Characterize Massive-MIMO Channels



Industrial displays on the cusp of a revolution - David Potts, Divisional Marketing Manager, Anglia Components Ltd.



The critical importance of Sicherheit in embedded software - Article by Mark

Pitchford of Lynx Software Technologies, Inc.



Q&A for Automotive Applications



Supercapacitors Find Applications in Hybrid Vehicles, Smartphones, and Energy

Harvesting By Jack Shandle, Mouser Electronics

An Overview of Medical Imaging By Bryon Moyer, Mouser Electronics

"We established the HPC initiative to service the unique needs of those end users with the highest compute-centric workloads in the industry," said **Corey Bell**, CEO of the Open Compute Project. "CERN has some of the most stringent workloads for low-latency computing, so this collaboration is a great opportunity to see the benefits of RapidIO in action."

The computing platform used for the collaboration is based on commercially available RapidIO-enabled 1U heterogeneous servers capable of supporting industry-standard servers, GPU, FPGA and low-power 64-bit SoCs, as well as top-of-rack RapidIO switches available from Prodrive Technologies.

About CERN openlab

CERN openlab, which is now entering its fifth three-year phase, is a unique public-private partnership between CERN and leading ICT companies. Its mission is to accelerate the development of innovative new solutions to be used by the worldwide LHC community. CERN openlab provides companies with a framework to test and validate cutting-edge information technologies and services in partnership with CERN.

About CERN

CERN, the European Organization for Nuclear Research, is a world leading laboratory for particle physics. It has its headquarters in Geneva. At CERN, physicists and engineers are probing the fundamental structure of the universe. They use the world's largest and most complex scientific instruments to study the basic constituents of matter – the fundamental particles.

About IDT

Integrated Device Technology, Inc., develops system-level solutions that optimize its customers' applications. IDT uses its market leadership in timing, serial switching and interfaces, and adds analog and system expertise to provide complete application-optimized, mixed-signal solutions for the communications, computing and consumer segments. Headquartered in San Jose, Calif., IDT has design, manufacturing, sales facilities and distribution partners throughout the world. IDT stock is traded on the NASDAQ Global Select Stock Market® under the symbol "IDTI." Additional information about IDT is accessible at www.IDT.com. Follow IDT on Facebook, LinkedIn, Twitter, YouTube and Google+.

IDT and the IDT logo are trademarks or registered trademarks of Integrated Device Technology, Inc. All other brands, product names and marks are or may be trademarks or registered trademarks used to identify products or services of their respective owners.



"Sensor Outlook: Where are Automotive Optical-Based Sensors Going?" - Article by Cliff

De Locht, Melexis

IoT meets Industry 4.0: Ecosystem Comes Together for Big Opportunities, Unique Challenges

The Connected Car



Driving SiC MOSFETs efficiently using the new generation of optocouplers - By Nick Bourne, Field Applications Engineer, Anglia Components



Electronics Components World

The Components Industry's E-Zine











HOME
BREAKING NEWS
TECH ARTICLES
PRODUCTS

CONTACT
ADVERTISE
ABOUT

©Electronic World Publishing 2014

OUR PUBLICATIONS:
EMSNow
Electronics Components World
Electronics Production World